SVENSK STANDARD SS-EN 62680-1-3

Fastställd	Utgåva	Sida	Ansvarig kommitté
2016-12-14	1	1 (1+174)	SEK TK 100

Gränssnitt för seriebuss för datakommunikation (USB) – Del 1-3: Gemensamma komponenter – Specifikation för kabel och anslutningsdon USB Type-C™

Universal serial bus interfaces for data and power –
Part 1-3: Universal Serial Bus interfaces –
Common components –
USB Type-C™ cable and connector specification

Som svensk standard gäller europastandarden EN 62680-1-3:2016. Den svenska standarden innehåller den officiella engelska språkversionen av EN 62680-1-3:2016.

Nationellt förord

Europastandarden EN 62680-1-3:2016

består av:

– **europastandardens ikraftsättningsdokument,** utarbetat inom CENELEC
– **IEC 62680-1-3, First edition, 2016 - Universal serial bus interfaces for data and power - Part 1-3: Universal Serial Bus interfaces - Common components - USB Type-C™ cable and connector specification**

utarbetad inom International Electrotechnical Commission, IEC.

ICS 33.120.20; 33.120.30; 35.200.00

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EUROPÄISCHE NORM

EN 62680-1-3

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English Version

Universal serial bus interfaces for data and power - Part 1-3: Universal Serial Bus interfaces - Common components - USB Type-C™ cable and connector specification (IEC 62680-1-3:2016)

Interfaces de bus universel en série pour les données et l'alimentation électrique - Partie 1-3 : Interfaces de bus universel en série - Composants communs - Spécification des câbles et connecteurs de type C™ de bus universel en série
(IEC 62680-1-3:2016)

Universelle serielle Bus Schnittstellen für Daten und Energie - Teil 1-3: Universelle serielle Bus Schnittstellen - Gemeinsame Komponenten - USB-Typ-C™ Kabel und Steckverbinder Spezifikation
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European Committee for Electrotechnical Standardization
Comité Européen de Normalisation Electrotechnique
Europäisches Komitee für Elektrotechnische Normung

CEN-CENELEC Management Centre: Avenue Marnix 17, B-1000 Brussels

Ref. No. EN 62680-1-3:2016 E

SEK Svensk Elstandard

European foreword

The text of document 100/2587/CDV, future edition 1 of IEC 62680-1-3, prepared by Technical Area 14 "Interfaces and methods of measurement for personal computing equipment" of IEC/TC 100 "Audio, video and multimedia systems and equipment" was submitted to the IEC-CENELEC parallel vote and approved by CENELEC as EN 62680-1-3:2016.

The following dates are fixed:

• latest date by which the document has to be implemented at national level by publication of an identical national standard or by endorsement	(dop)	2017-06-21
• latest date by which the national standards conflicting with the document have to be withdrawn	(dow)	2019-09-21

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UNIVERSAL SERIAL BUS INTERFACES FOR DATA AND POWER –

Part 1-3: Universal Serial Bus interfaces – Common components – USB Type-C™ cable and connector specification

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The text of this standard was prepared by the USB Implementers Forum (USB-IF). The structure and editorial rules used in this publication reflect the practice of the organization which submitted it.

The text of this standard is based on the following documents:

CDV	Report on voting
100/2587/CDV	100/2681/RVC

Full information on the voting for the approval of this standard can be found in the report on voting indicated in the above table.

A list of all parts in the IEC 62680 series, published under the general title *Universal serial bus interfaces for data and power*, can be found on the IEC website.

The committee has decided that the contents of this publication will remain unchanged until the stability date indicated on the IEC website under "http://webstore.iec.ch" in the data related to the specific publication. At this date, the publication will be

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This standard is the USB-IF publication USB Type-C™ Cable and Connector Specification Revision 1.1.

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Universal Serial Bus Type-C Cable and Connector Specification

Revision 1.1
April 3, 2015

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Revision History

Revision	Date	Description
1.0	August 11, 2014	Initial Release
1.1	April 3, 2015	Reprint release including incorporation of all approved ECNs as of the revision date plus editorial clean-up.

1 Introduction

With the continued success of the USB interface, there exists a need to adapt USB technology to serve newer computing platforms and devices as they trend toward smaller, thinner and lighter form-factors. Many of these newer platforms and devices are reaching a point where existing USB receptacles and plugs are inhibiting innovation, especially given the relatively large size and internal volume constraints of the Standard-A and Standard-B versions of USB connectors. Additionally, as platform usage models have evolved, usability and robustness requirements have advanced and the existing set of USB connectors were not originally designed for some of these newer requirements. This specification is to establish a new USB connector ecosystem that addresses the evolving needs of platforms and devices while retaining all of the functional benefits of USB that form the basis for this most popular of computing device interconnects.

1.1 Purpose

This specification defines the USB Type-C™ receptacles, plug and cables.

The USB Type-C Cable and Connector Specification is guided by the following principles:

- Enable new and exciting host and device form-factors where size, industrial design and style are important parameters
- Work seamlessly with existing USB host and device silicon solutions
- Enhance ease of use for connecting USB devices with a focus on minimizing user confusion for plug and cable orientation

The USB Type-C Cable and Connector Specification defines a new receptacle, plug, cable and detection mechanisms that are compatible with existing USB interface electrical and functional specifications. This specification covers the following aspects that are needed to produce and use this new USB cable/connector solution in newer platforms and devices, and that interoperate with existing platforms and devices:

- USB Type-C receptacles, including electro-mechanical definition and performance requirements
- USB Type-C plugs and cable assemblies, including electro-mechanical definition and performance requirements
- USB Type-C to legacy cable assemblies and adapters
- USB Type-C-based device detection and interface configuration, including support for legacy connections
- USB Power Delivery optimized for the USB Type-C connector

The USB Type-C Cable and Connector Specification defines a standardized mechanism that supports Alternate Modes, such as repurposing the connector for docking-specific applications.

1.2 Scope

This specification is intended as a supplement to the existing *USB 2.0*, *USB 3.1* and *USB Power Delivery* specifications. It addresses only the elements required to implement and support the USB Type-C receptacles, plugs and cables.

Normative information is provided to allow interoperability of components designed to this specification. Informative information, when provided, may illustrate possible design implementations.